

Inovação além da computação com UCS-X e Intersight

Quint@s Quinze - 4 de maio de 2023

Rafael Guerra
Technical Solutions Architect - Cloud & Data Center Brazil

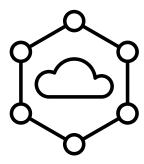




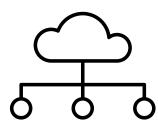
Agenda



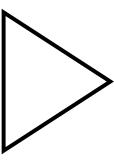




Know the UCS-X



Use Cases



Demo

Hardware Evolution in Cloud Era





Compute Platform Directions 2022 and Beyond Disruptive Eco-System Ingredients



Compute

High Watt CPU, GPU, DPU, IPU Persistent Memory, Liquid Cooling, SmartNIC, FPGA Offload



Protocols

RoCEv2, SMBDirect, NVMe-oF, GPUDirect



Fabric

400G PCIe Gen4/Gen5/Gen6 CXL 1.1/2.0/3.0



Storage

32/64TB NVMe Drive, EDSFF, Low Latency NVMe

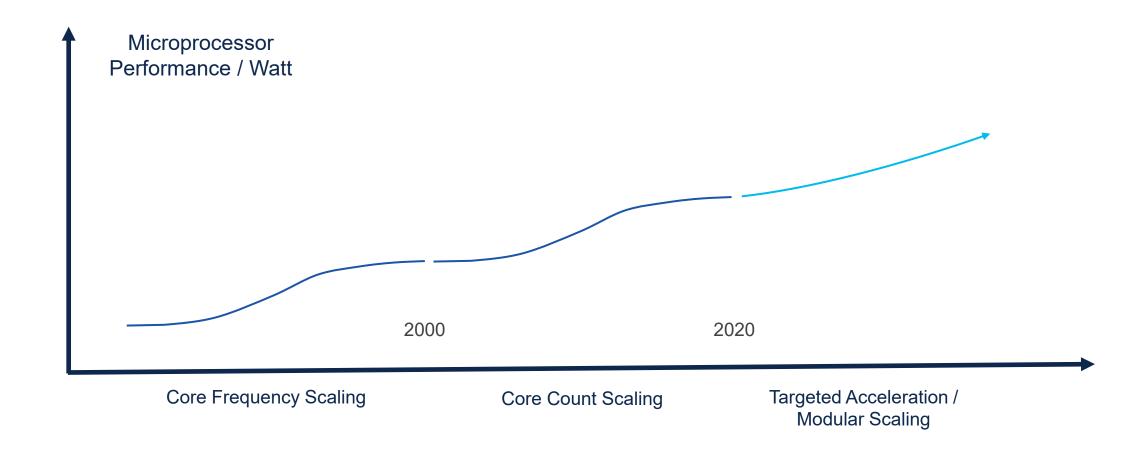


Silicon Directions





Performance Efficiency - Server Market





Hardware Disaggregation





10 Interconnect

Accelerated Computing Software on Silicon Cognitive Computing, **Delivers Application Specific** acceleration AI/DL/ML workload Flex IO Interconnect Core/Memory/IO SCM/PMEM BW In memory Compute Workload Scaling Memory Capacity/BW

How do interconnects meet new requirements?

- Latency Guarantees
- Coherency (Load / Store)

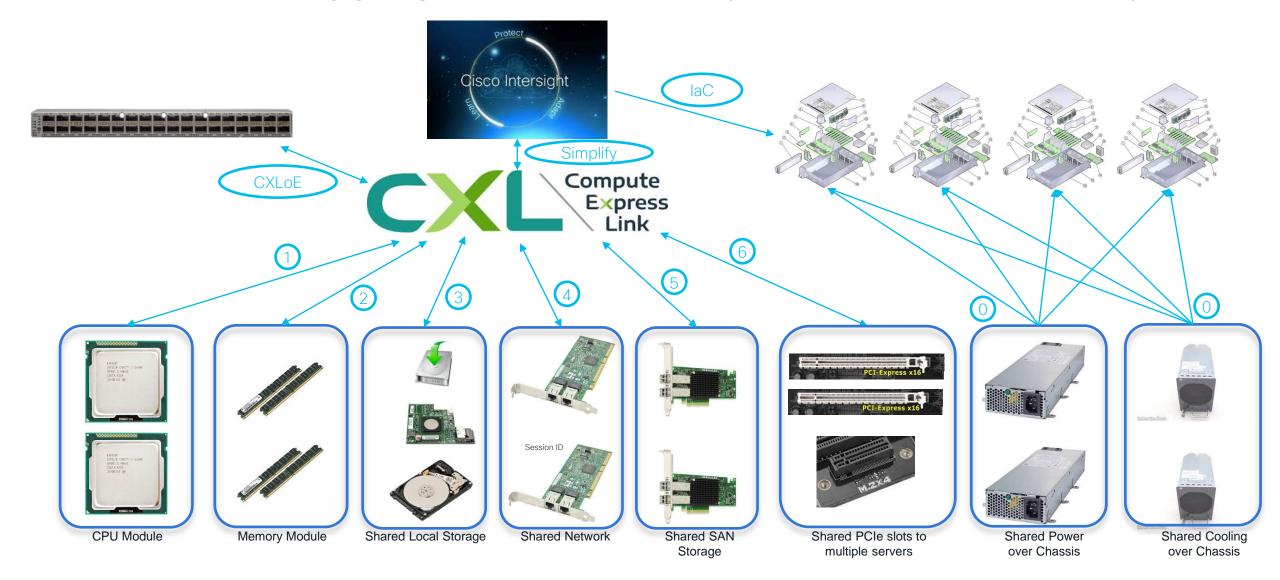
Options:

- Ethernet
- PCle Gen4,5,6,X
- CCIX, OpenCAPI
- Gen-Z
- Infiniband
- NVLink
- CXL (Cisco is one of the Promoters/Founding Members)

Industry is investing in multiple solutions, CXL is gaining most traction, need a flexible architecture to support multiple approaches.

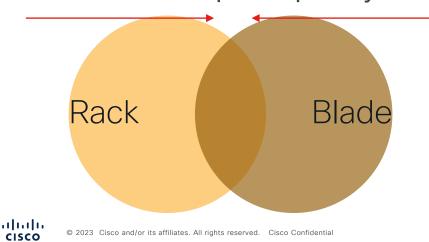
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Server Dis-Aggregation: Driven by Cost & Sustainability



Blade vs. Rack? That Separation is also Fading...

- New compute innovations are blurring long-standing assumptions
- These innovations have impacts to networking, security, storage, etc.
- A robust orchestration layer is needed to keep simplicity



Session ID

Item	Rack	Blade	Future
More Drives	24-48	2-4	6+N
More PCle	2-12	2-4	2+N
Standard PCle	Open	Closed	Open
Higher Power Peripherals / Cards	1-6	1	1+N
Direct to ToR switch	Always	IO Modules	Either
Unified IO	Separate	Default	Default
Shared Power & Cooling	Minimal	Default	Default
Unified Management	Minimal – no blade	Default – no rack	Default - any form factor
Compute Fabric (CXL, GenZ, etc.)	Add on	Add on	Integrated

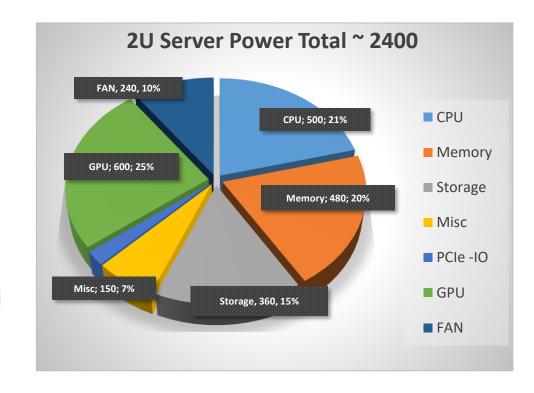
Liquid Cooling





Power & Cooling

- CPU, GPU and Switch ASIC power requirements moving from ~205W TDP today to 350W+ in the coming years
- Traditional fan cooling consumes lot of power and less efficient as system power increases
- Passive cooling is approaching its limitation
- Liquid cooling technology to address future cooling requirement with significantly better cooling efficiency & reduced noise levels
- Closed loop liquid cooling provides a retrofit solution
- Future Data Center designs will need to provision for Rack level liquid cooling infrastructure (with external Cooling Distribution Unit - CDU)



From Air to Liquid Cooling

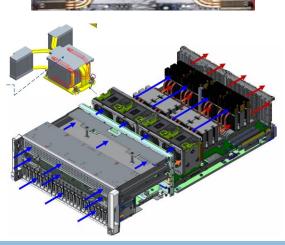
Air-Cooled Traditional

Closed Loop-Liquid Cooling

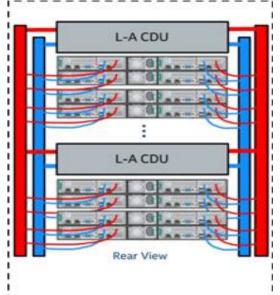
Liquid Cooling Rack-level close loop

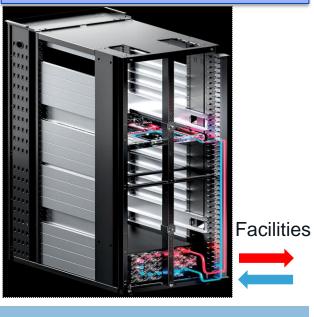
Liquid Cooling Rack-level open loop











- Embedded Heat Pipe Heat sinks carrying water droplets
- Fan primary mover of hot air
- Maxes @350 W TDP
- About 10% Cooling Power
- Exponentials increase in cooling power beyond 350W TDP

Close Loop Cold Plates liquid cooling

Session ID

- Single Phase –Leakage concern
- Pump/Radiator circuitry
- Radiator is air-cooled
- @500 W TDP for 2U
- @15% Cooling Power for 500 W
- Lower Cooling Power for 350W TDP
 - Better for NetZero
- Blades stay at 350 W

- Open Loop Cold Plates
- No coolant connection outside of the rack
- Single Phase(water) or 2 Phase (refrigerant)
- 500 W TDP
- Common for rackmounts and blades
- About 15% Cooling Power when paired with Liquid-Air CDU
 - Minimal advantage for NetZero

- Open Loop Cold Plates
- Coolant collection tied to facilities
- Single Phase (water) 2 Phase (refrigerant)
- 500 W TDP and beyond
- Works for rackmounts and blades
- Common for rackmount & blades
- About 5% Cooling Power when paired with Liquid-Liquid CDU
 - Better for NetZero
 - About 1 kW of cooling power savings for a loaded UCS-X



Persistent challenges for IT

Architectural silos spawn islands of infra and operations

Application diversity drives infrastructure diversity

Fragmented technologies impede time to value





Reduced visibility, increased cost and risk

Specialized systems increase operational complexity

Valuable IT energy wasted on platform integration



Intel® Xeon® Roadmap Update

(2S)



Early 2023 2024+ 2017 - Current **April** 2021 Cascade Lake Ice Lake Sapphire Rapids **Emerald Rapids Next Rapids** 2nd Gen Intel® Xeon® SP 3rd Gen Intel® Xeon® SP 4th Gen Intel® Xeon® SP 4th Gen Intel® Xeon® SP Future Gen Intel® Xeon® SP Late 2023 - Early 2024 2024+ Q1 2023 Shipping 28 cores, Intel 14nm 40 cores, Intel 10nm 60 cores, Intel 7 (10ESF) 64 cores, Intel 7 (10ESF) >64 cores 270W, 8CH DDR4-3200 205W, 6CH DDR4-2933 350W, 8CH DDR5-4800 350W. 8CH DDR5-5600 8CH DDR5-6400 48L PCle 3.0 64L PCle 4.0 80L PCle 5.0, CXL 1.1 80L PCle 5.0, CXL 1.1 PCle 5.0, CXL 2.0 3x UPI 1.0 (10.4 GT/s) 3x UPI 1.0 (11.2 GT/s) 4x UPI 2.0 (16 GT/s) 4x UPI 2.0 (20 GT/s) Advanced UPI speed Intel PMem™ 200 Series Intel PMem™ 100 Series **Built-In Accelerators** Improved Perf. by ~15% Modular Architecture Purley Platform Whitley Platform **Eagle Stream Platform Next Stream Platform** (2S/4S/8S) (2S/4S/8S) (2S/4S/8S)

> 4th Gen Xeon SP (Sapphire Rapids) Brings a Massive Jump in Platform Capabilities and Performances over 3rd Gen Ice lake



DDR5 vs DDR4 - DDR5 Benefits



M7 Memory DIMM server technologies	DDR4	DDR5	DDR5 Benefits	
Speed	1.6 to 3.2Gbps data rate; Max 3200MT/s	4.8 to 8.4Gbps data rate; First generation: 4800MT/s	DDR5 debuts at 4800MT/s, 50% increase over DDR4-3200	
Operational voltage	1.2 Volts	1.1 Volts	Reduce power; at 1.1V, DDR5 consumes ~20% less power than DDR4	
Power Management	On Mother board	On DIMM PMIC	Better power efficiency, better scalability; Improves signal integrity, and reduce noise	
DRAM DIMM Type	RDIMM (16GB-64GB) LRDIMM (128GB, 256GB)	RDIMM	Registered DIMM only	
Channel architecture	72-bit data channel (64data + 8 ECC) 1 channel per DIMM	40-bit data channel (32 data + 8 ECC 2 channels per DIMM	Higher memory efficiency and lower latencies of data access for the memory controller	
On Die ECC (Error Correction Code)	No	Yes	Correct bit errors within the DRAM chip; Increase reliability, reduce defect rates	
Max DRAM die density	Up to 16Gb SDP> 64GB DIMM	Up to 64Gb SDP> 256GB DIMM Higher Single Die per Package DIMM, First gen: 16Gb SDP, 64GB DIMM eventually saving cost		

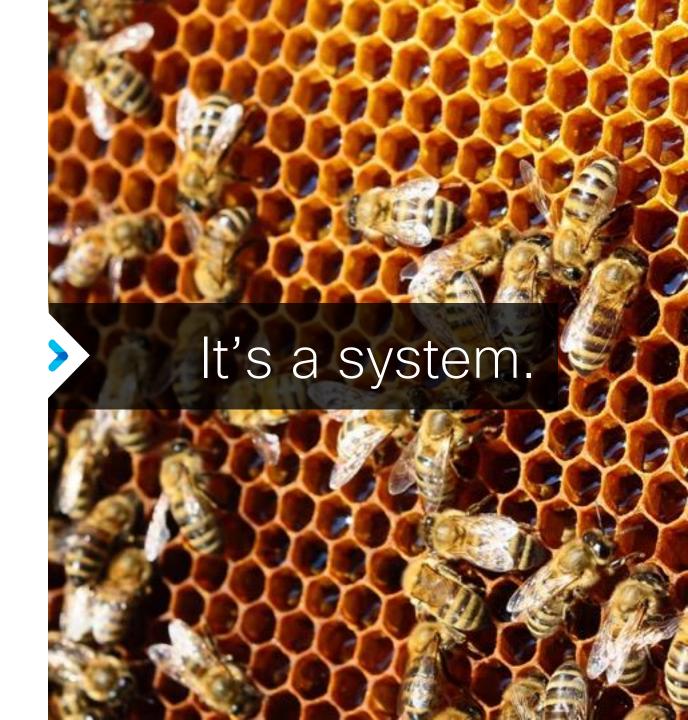
DDR5 is faster, more efficient, and will scale to higher densities/speeds.

On M7, with Sapphire Rapids, we will support DDR5-4800, 50% BW increase over M6.



Cisco UCS It's not a server.





UCS Fabric Simplified

TCO Reduction Simplicity Resiliency Fabric Interconnect LAN 10/25/40/100G Unified Converged Fabric Appear as Management vNICs FEX / IFM physical NICs Ethernet vHBAs and HBAs to Storage/FC host OS

TRADITIONAL RACK



Ad Hoc and Inconsistent

TRADITIONAL BLADE



Structured, but Siloed and Complicated

CISCO UCS



Simplified, Optimized and Automated



7th Gen UCS Servers and GPU support

X-Series Compute Nodes



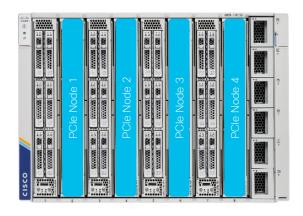
UCS X210C M7 (2-socket)

UCS X410c M7 (4-socket)



Run any app with adaptable system

PCIe Nodes with Intel or nVidia GPU + UCS X-Fabric Technology



Accelerate modern apps

UCS C-Series Servers



UCS C220 M7 Rack Server



UCS C240 M7 Rack Server

Run more apps in a familiar form factor



Meet the UN/BOX



UCS X-Series powered by Cisco Intersight









Radically simplified hybrid cloud infrastructure

Simplify with cloud-operated infrastructure



Simplify with a system designed for modern applications



Simplify with a system engineered for the future







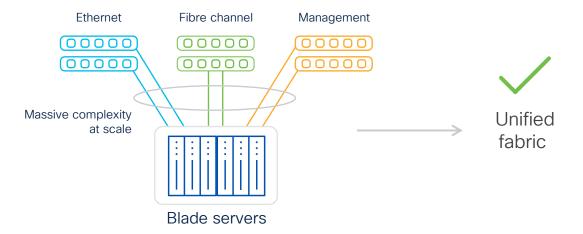
UCS X-Series



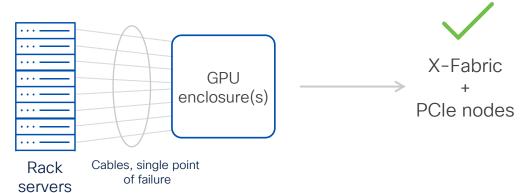
Industry-leading simplicity

Conventional approaches

1 | Silos of multiple ethernet and SAN fabrics and adapters



2 | Complex PCIe connectivity to external accelerators

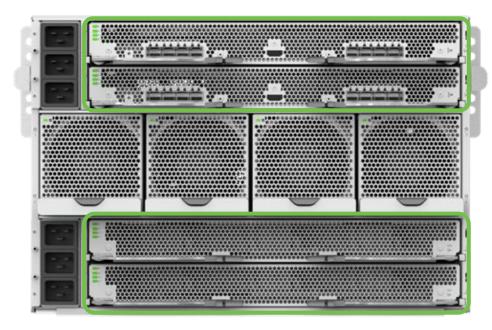


Cisco solution

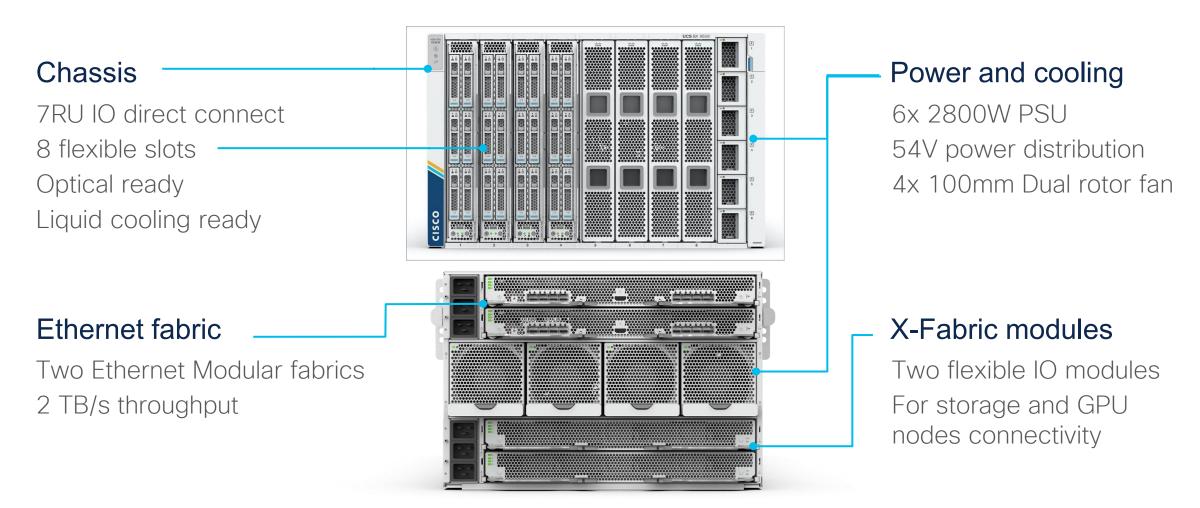
UCS X-Series

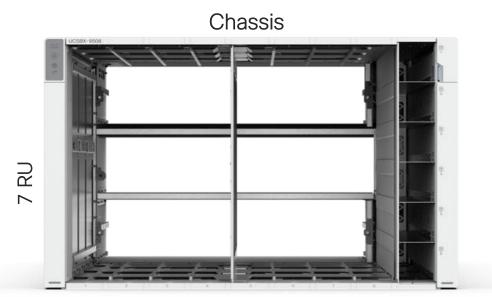


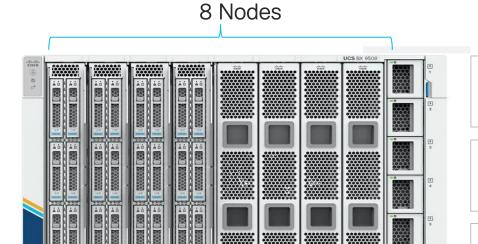
Cisco Intersight



UCS X9508 System chassis



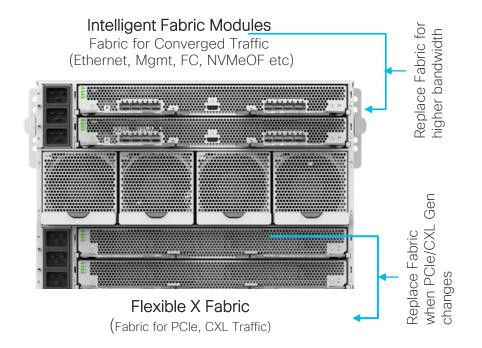




Compute Node With 6xSFF, 2xM.2

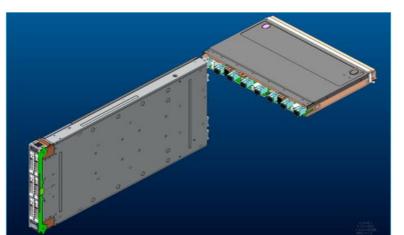
500+ Cores, ~100TB Mem, >1PB Drives,

PCle Nodes
Drive Nodes*



Backplane less design For Fabric

(Simpler Upgrade, No Cap on bandwidth)





Power and Cooling Innovation!

Power Distribution, Fan Speed Sensors, Fan Control Policy, Air Flow, Others

High Energy Efficiency and Power Envelope For Future

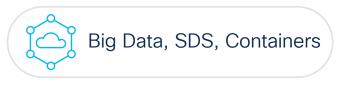




Consolidate Rack Workloads



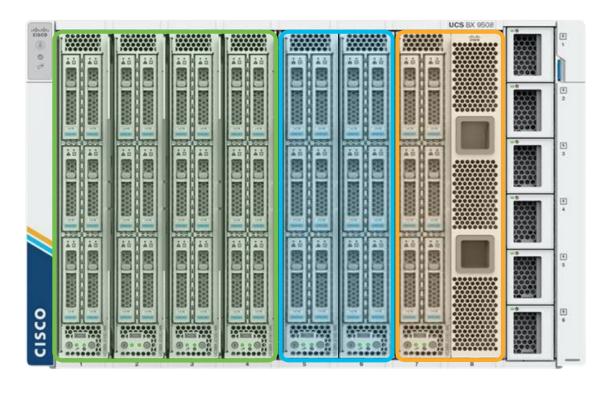






Traditional Blade Workloads

UCS X-Series with X-Fabric



Up to 960

Cores per Chassis (M6 or M7) GPUs per Chassis

(intel) NVIDIA.

200G

Bandwidth to compute node

1 PB

of storage



UCS X210c M7 2S Compute Node

Key Features



Up to 2 Intel 4th Gen Xeon CPUs



Memory

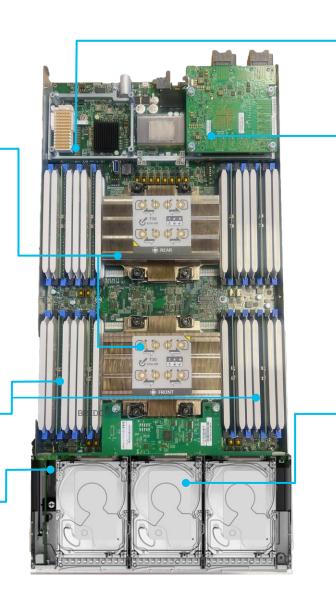
Up to 32x DDR5 4800 MT/s DIMMs

GPU

Up to 2 x PCle GPU

Up to 2 x NVMe PCle Drives

Op to 2 x Invivie Pole Drives



X-Fabric Mezz

Connect to PCle Node

In future, to Memory/Drive Nodes

VIC

Up to 2 VICs

100G Cisco mLoM

25G Cisco mLoM

25G Cisco VIC Mezz

Agg NW 200G per node

Drives

2 x M.2 SATA HW Raid1/ 2 x M.2 NVMe
Up to 6 x SAS/SATA/NVMe

- RAID Controller for SAS/SATA
- Up to 90TB (15TB x 6) per Blade



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UCS X410c M7 4S Compute Node

Key Features

Form Factor

Occupies two slots in chassis

CPU

Up to 4 Intel 4th Gen Xeon CPUs

X-Fabric Mezz

Connect up to 2x PCIe Nodes
In future, to Memory/Drive Nodes

Memory

Up to 64x DDR5 4800 MT/s DIMMs



VIC

200G Aggregate/ 100G per Fabric 100G 5th Gen VIC mLOM

OI

25G 5th Gen VIC mLOM 25G 5th Gen VIC Mezz

Drives/GPU

Front Mezz options

- 1. 6 SAS/SATA with HW RAID
- 2. 6 NVMe PCle Gen4 x4
- 3. 2 NVM@ PCle Gen4 x4, plus 2 PCle GPUs

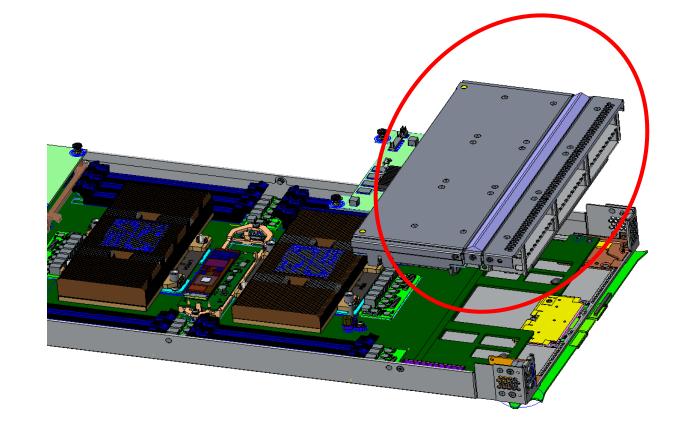
Internal

- 1. 2x M.2 SATA HW RAID1
- 2. 2x M.2 NVMe



GPU on X210C

- 2x T4 (with modified heat sink) in the front mezz slot
- Supports 2x NVME drives
- High GPU density solution with GPU node (24xT4 in 7RU with 4 nodes)







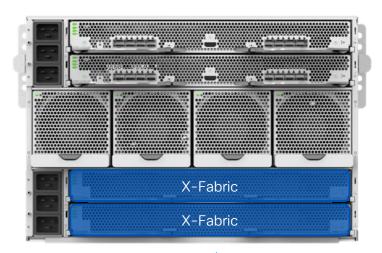
UCS X-Fabric Technology and PCle Nodes with GPU

Open, modular design enables compute and accelerator node connectivity

PCIe node supports up to

- 4x Intel Data Center GPU Flex 140*
- 2x Intel Data Center GPU Flex 170*
- 2x Nvidia A16
- 2x Nvidia A40
- 4x Nvidia T4
- 2x Nvidia A100





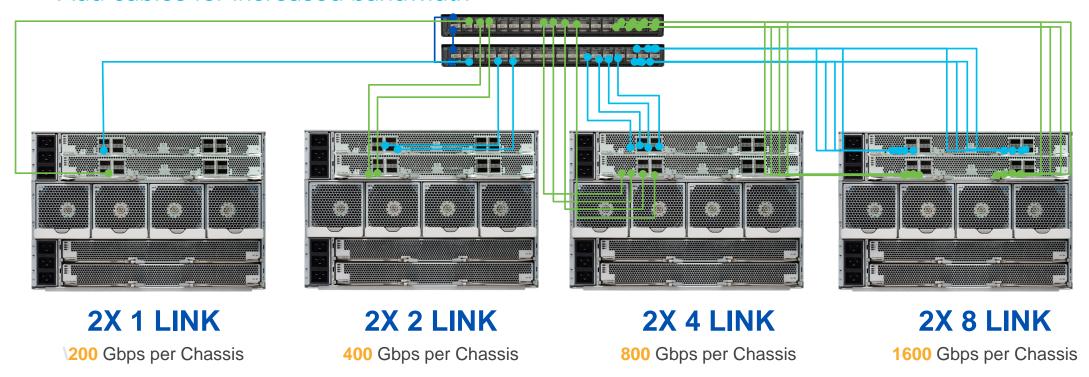
UCS X-Fabric Technology

- Based on native PCle Gen. 4
- Provides GPU acceleration to enterprise application
- ✓ No backplane or cables = Easily upgrades

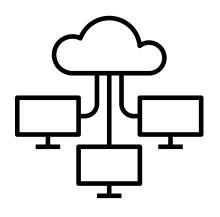


UCS Fabric Topologies : Chassis Bandwidth Options for X-series

- Wire once for Connectivity and Discovery
- Add cables for increased bandwidth



Use Cases







Remote Work (VDI)

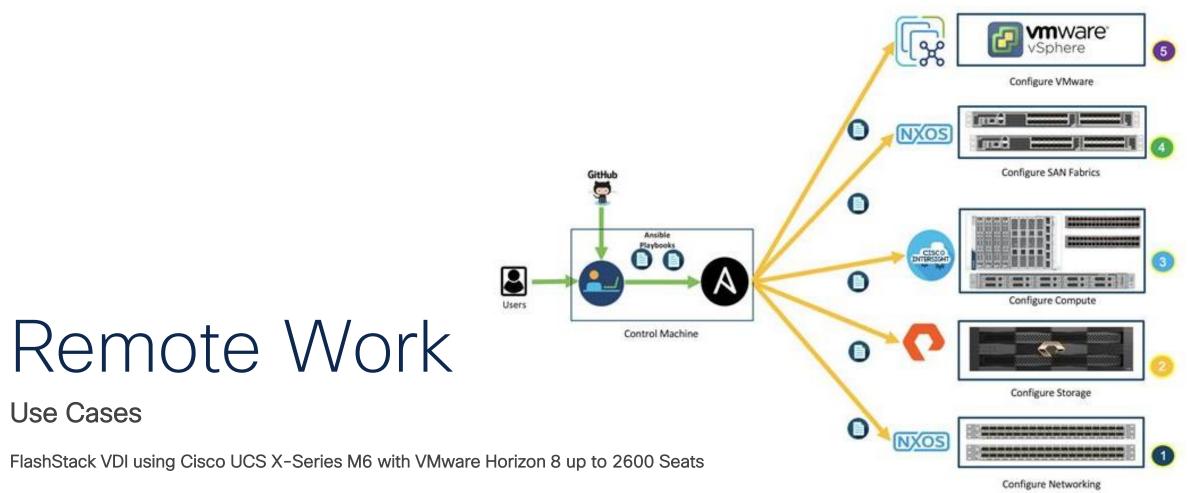
Cloud Native

Critical Apps





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https://www.cisco.com/c/en/us/td/docs/unified_computing/ucs/UCS_CVDs/flashstack_ucs_x_series_vmware_vsphere.html

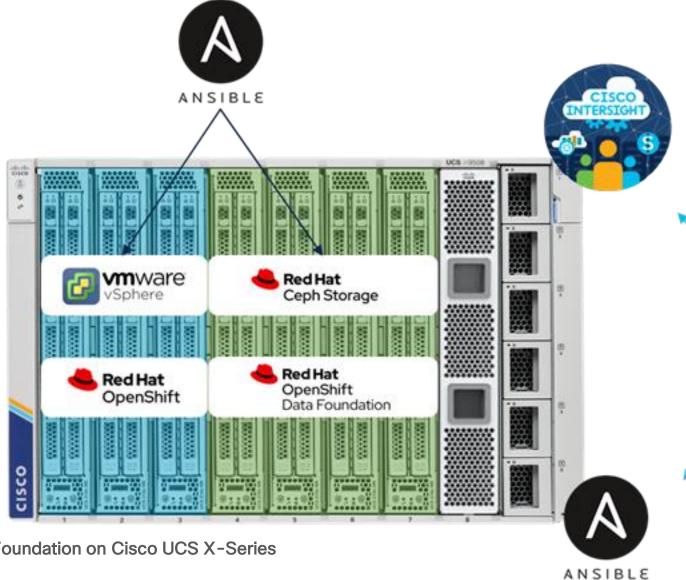




Use Cases

Red Hat OpenShift Container Platform with OpenShift Data Foundation on Cisco UCS X-Series

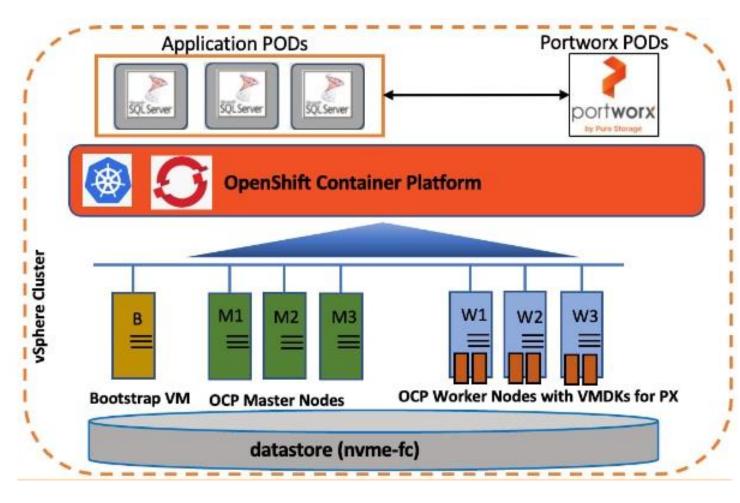
https://www.cisco.com/c/en/us/td/docs/unified_computing/ucs/UCS_CVDs/ucs_xseries_ocp_ci.html





Critical Apps

Use Cases

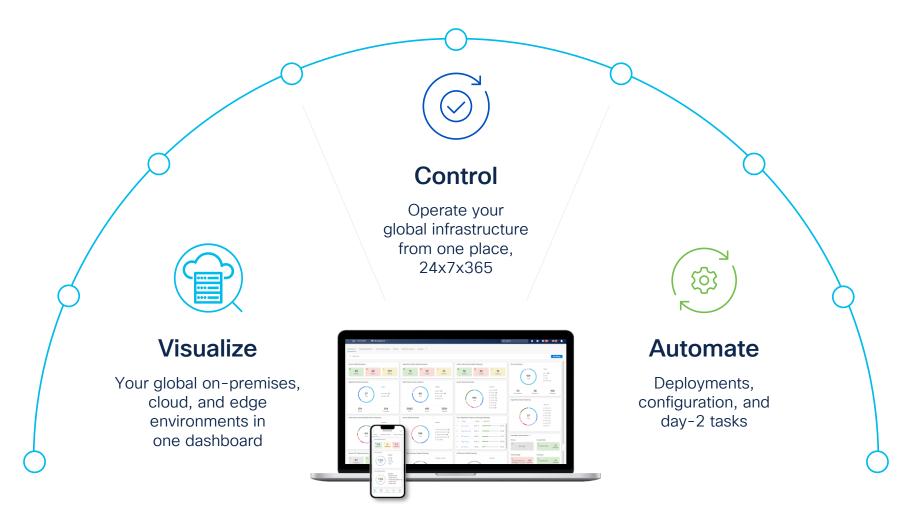


FlashStack for SQL Server 2019 with Cisco UCS X-Series and Pure Storage FlashArray//XL170

https://www.cisco.com/c/en/us/td/docs/unified_computing/ucs/UCS_CVDs/ucs_xseries_flashstack_sql_openshift.html

Modernize infrastructure management

Cisco Intersight Infrastructure Service

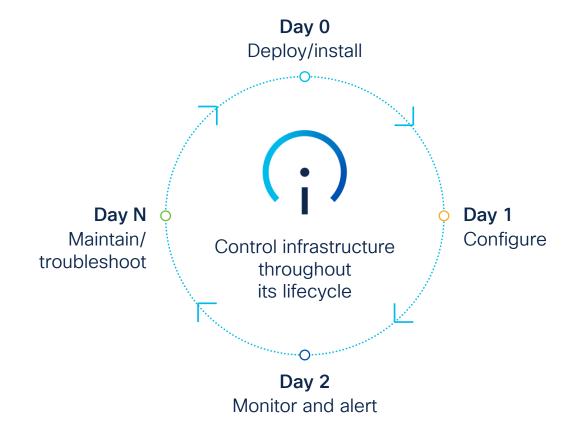




Control

Infrastructure lifecycle management

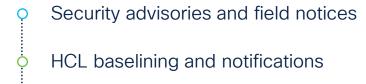
Deploy, configure, and operate servers, VMs, storage, and networking throughout their lifecycle, from one place... anytime, anywhere



"Intersight has reduced the weight of routine deployment and monitoring tasks so we can focus on the work that helps our business."

Prevent and resolve

Infrastructure issues with custom insights and automated support



- Proactive RMAs
 - Connected support (TAC)
 - Firmware upgrades
- Compliance

"You know you are being proactive when an engineer replaces a hard drive that was displaying anomalies before it fails and causes problems downstream."

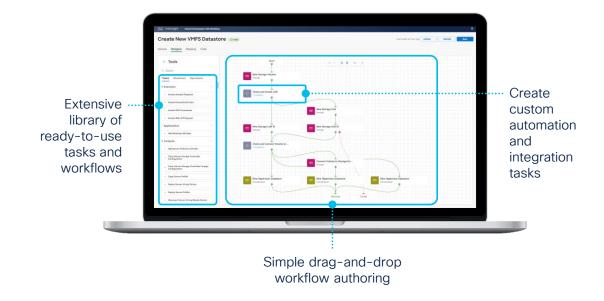
Automate

Create automated workflows to...

- Accelerate delivery of apps and infrastructure
- Reduce risk with standardization
- Simplify cross-domain orchestration

Two options

- Workflow designer
 Drag-and-drop workflow authoring
- APIs/SDKs
 For using your existing automation tools (Ansible, Terraform, etc.)



"With consistent and repeatable workflows offered by Cisco Intersight, IT teams can save time and decrease operational costs."

Integrate

Cisco Converged Infrastructure Solutions with UCS X-Series



Simplified cloud-based management of solution components

Monitoring, orchestration, and workload optimization for different layers of solutions

Storage plugins







See storage capacity, controllers, configuration, snapshots, and replication

Automate storage management and orchestration

Use storage task library to create and execute workflows

ServiceNow plugin

servicenow

Incident management

Basic configuration

Inventory module

Third-party server support







See inventory and health

Add to automated workflows



Deployment options



Intersight.com

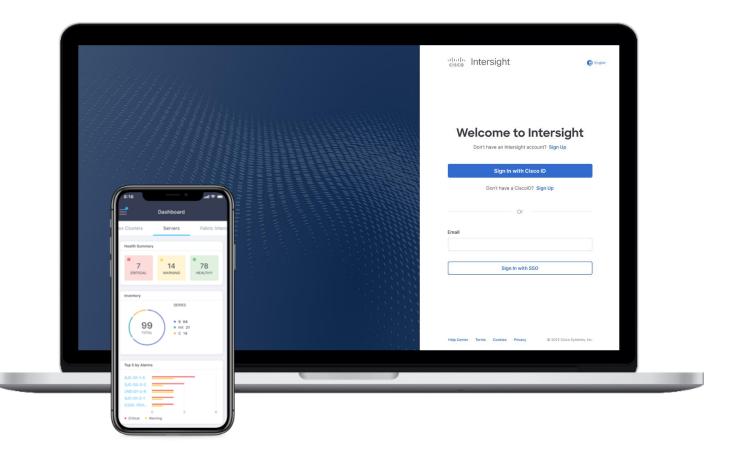
Cisco-hosted SaaS



Virtual appliance

Connected
Private (air-gapped)







When it comes to efficiency, rack servers fall short

X-Series advantages over rack servers



Modular

Produces roughly 50% lower consumption of raw materials over three generations than rack servers



Energy-efficient

Reduces the number of necessary inverters, power conversions, and by design runs more efficiently lowering total energy consumption



Usage Aware

Uses constant monitoring and cooling algorithms to dynamically adjust power usage for optimal efficiency

Sustainable by design



Sustainable packaging

Offers multipack options to reduce packaging for high-volume orders



Recycled materials

Plastic parts use post-consumer recycled resin



Efficient Components

Utilizes efficient components like high-efficiency, Titanium-rated power supplies

Embedding sustainability through the product lifecycle



>⊟ Supply Chain Sustainability

Cisco works to uphold human rights, promote worker well-being and minimize negative environmental impacts in our supply chain.



Product Takeback and Reuse

Return end-of-use gear for free in a simple, secure, and sustainable way. Certified remanufactured products and available through Cisco Refresh.



X-Series industry-leading sustainability by design



Architectural Po	wer & Lifecyo	cle Optimization
------------------	---------------	------------------

Standard out of the box

- Unified IO and 100G for all servers reduces adapter, cabling, network and storage port needs
- Efficient 54V power distribution to minimize transmission and conversion loss within all system elements
- Input power monitoring at system level allows a quicker reaction based on real usage to realize 3-4% overall savings
- Titanium rated PSU

Optional add-on configuration

 X fabric allows for lifecycle upgrades of server modules while extending the life of many existing components (PSU, Fan, Case, Risers, and more in future)

Cooling & Fan Optimization

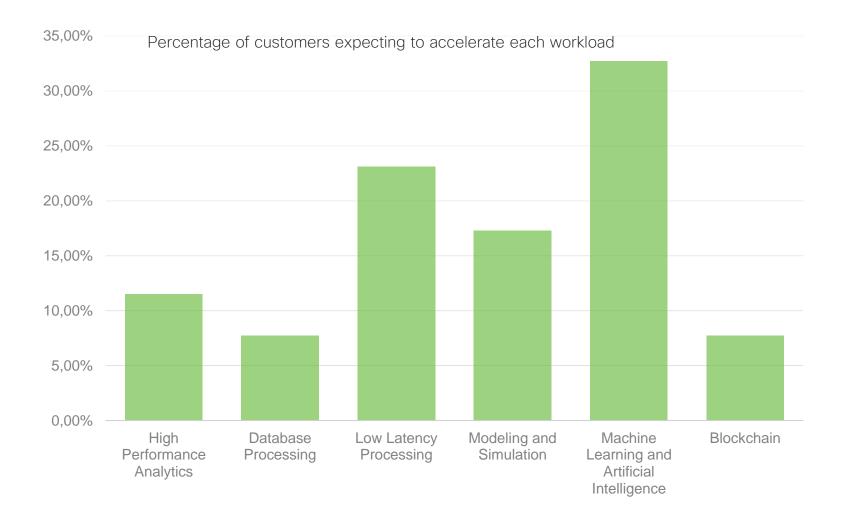
- Zone-based cooling to intelligently operate fans where they are needed and not running them at common largest need
- Large real estate footprint on server blade modules allows for simpler airflow efficient fan power usage

 Midplane free design allows for future technologies such as liquid cooling to change the math on PUE in your DC without forklift upgrade of entire racks



Workloads Trending Toward Liquid Cooling

Using GPUs, FPGA,
Accelerators and
Frequency
Optimized
Processors





Intersight Infrastructure Services Simplifies Sustainable Operations



Power policies

- · Global setting for Chassis Power behavior
- Redundancy, Power Save modes

Dynamic power rebalancing

- · Competitive advantage
- Chassis and Rack group level redistribution of available power

Power allocation policy

 Global setting to specify policy-based power capping or manual node power cap is used

Power profiling policy

- · Node, Blade and Rack server
- Tests and determines actual min and max power draw

Power group policy

 Set of chassis that draw power from the same PDU and maintain under the advisable limit

Server power control policy

- · Chassis and Rack level
- Priority set to calculate initial power allocation and discretionary use

Power capping policy

- Node, Blade and Rack server
- Individual and group power capping
- Group level or individual manual

Fan speed control policy

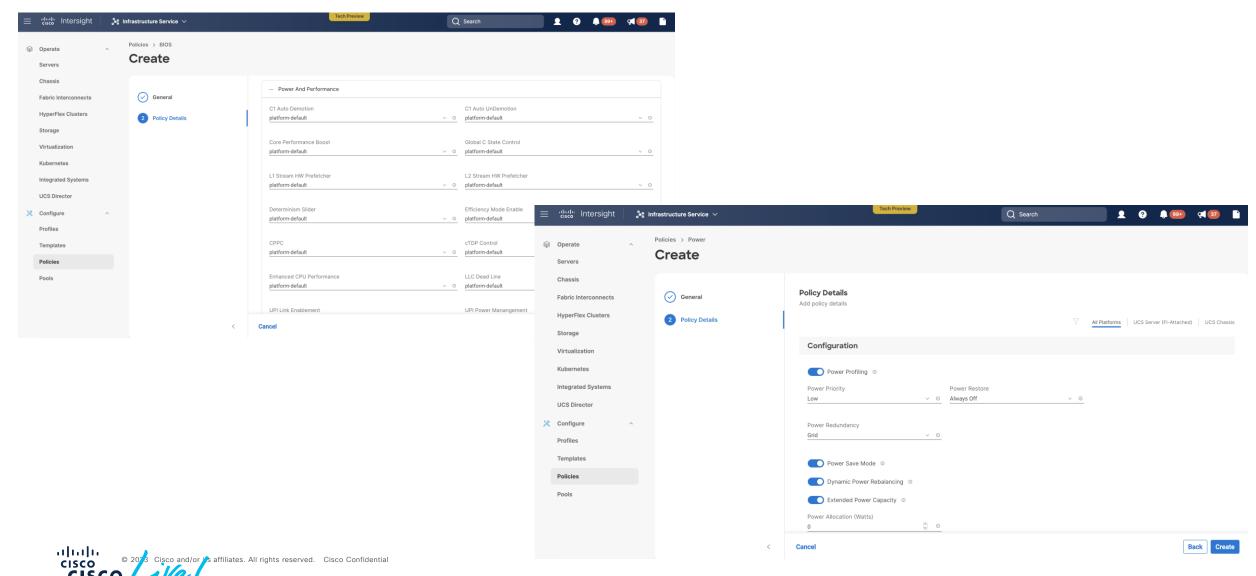
- Global or individual non disruptive server setting
- Controls power usage and airflow noise levels

BIOS and OS power policy

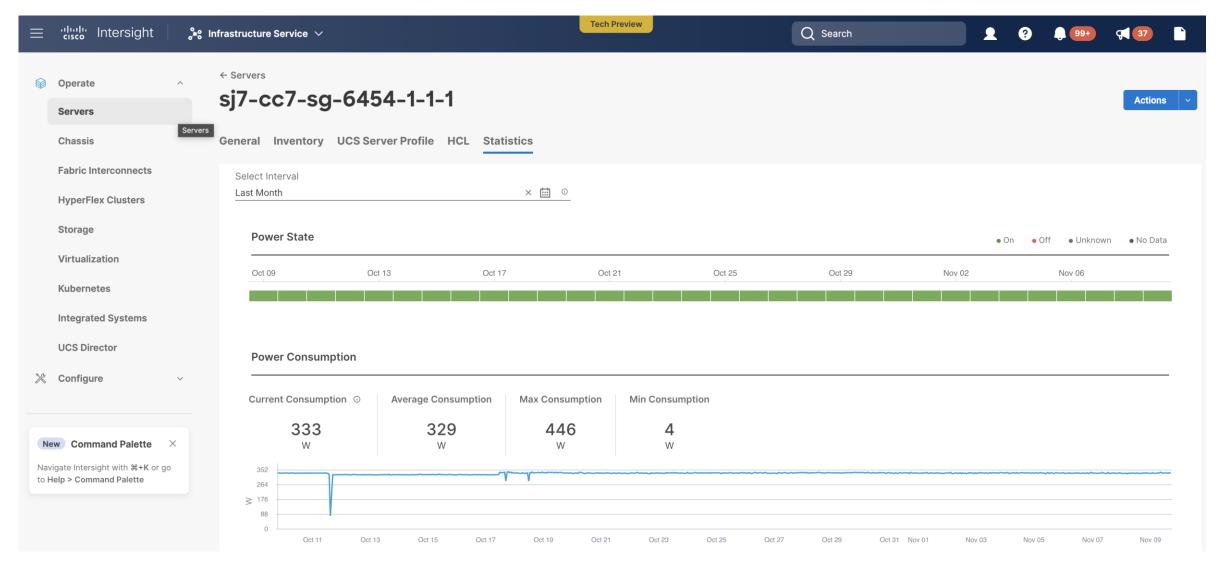
- Use BIOS tokens to adjust power based on app needs
- OS level power recommendations



Intersight Services simplifies power management operations-example



Visibility & Trending Server Power Utilization





Future-ready design

Engineered for the next decade

Protect investments and focus on innovation



2022



2030 2030 2030

Liquid-cooling

Silicon photonics

Next gen. fabrics

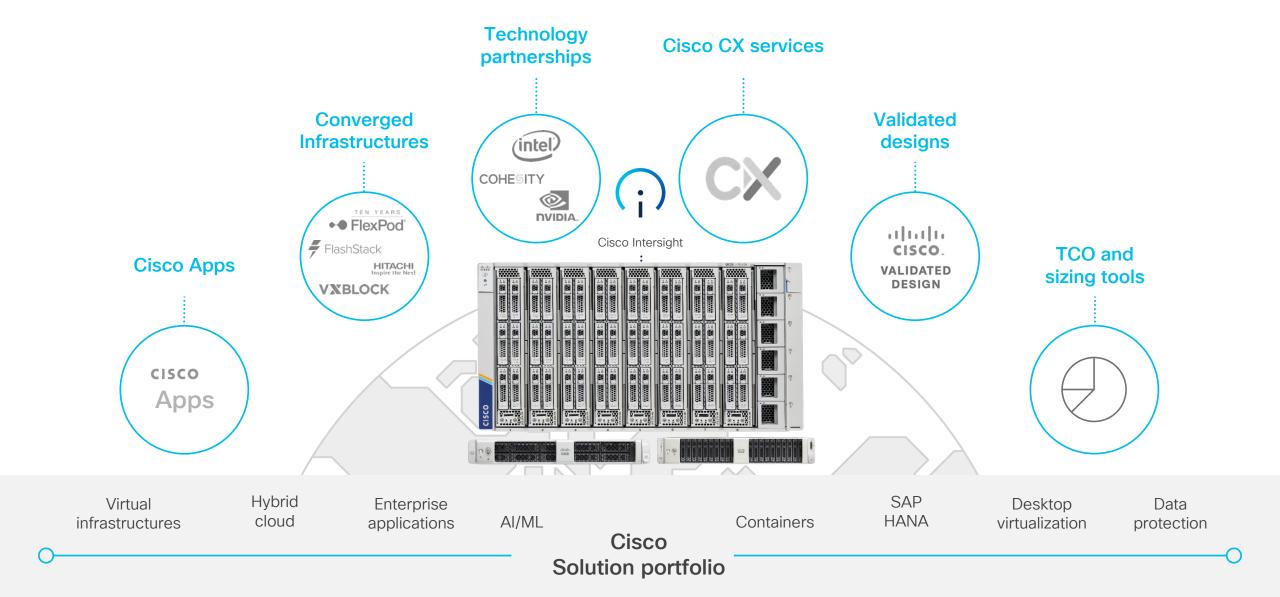
Power and cooling capacity

Future accelerators

Intel/AMD roadmap



Computing for the next decade



Resources



Data Center Design Guides:

https://www.cisco.com/c/en/us/solutions/design-zone/data-center-design-guides/data-center-design-guides-all.html

Cisco UCS X-Series Modular System:

https://www.cisco.com/c/en/us/products/servers-unified-computing/ucs-x-series-modular-system/index.html





Cisco Intersight help center:

https://intersight.com/help/saas

UCS Solutions Team GitHub Repository:

https://github.com/ucs-compute-solutions







The bridge to possible